

L Number	Hits	Search Text	DB	Time stamp
-	335	73/818.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	20244	((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:50
-	16023	((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) and (housing cas\$4 body packag\$4 structure mount\$4 backing assembl\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:44
-	8993	((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) same (housing cas\$4 body packag\$4 structure mount\$4 backing assembl\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:48
-	15971	((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) and (housing case casing body packag\$4 structure mount\$4 backing assembl\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:50
-	375	(((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) same (housing cas\$4 body packag\$4 structure mount\$4 backing assembl\$4)) and 73/\$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:50
-	719	(((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) and (housing case casing body packag\$4 structure mount\$4 backing assembl\$4)) and 73/\$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/07 15:50
-	77	(((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) same (housing cas\$4 body packag\$4 structure mount\$4 backing assembl\$4)) and 73/\$6.ccls.) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 14:34
-	144	(((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4))) and (housing case casing body packag\$4 structure mount\$4 backing assembl\$4)) and 73/\$6.ccls.) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:20
-	0	(((((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4))) same (housing cas\$4 body packag\$4 structure mount\$4 backing assembl\$4) same ceramic)) and 73/\$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 17:28
-	2	(((((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4))) same (housing casse casing body packag\$4 structure mount\$4 backing assembl\$4) same ceramic))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 15:04
-	6	(((((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4))) same (housing casse casing body packag\$4 structure mount\$4 backing assembl\$4) same ceramic))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:46

-	33	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 tesnion\$4 break\$4 push\$4)) and ((ceramic) near4 (housing case casing body packag\$4 structure mount\$4 backing assembl\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:01
-	130	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 tension\$4 break\$4 push\$4)) and 73/\$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:18
-	35	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (bond\$4) near6 (pull\$4 tension\$4 break\$4 push\$4)) and 73/\$6.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:28
-	150	(((((lead wire cable strand) near6 (pull\$4 push\$4 test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (bond\$4))) and (housing case casing body packag\$4 structure mount\$4 backing assembl\$4)) and 73/\$6.ccls.) and ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:29
-	0	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4)) same (clamp\$4 grip\$4) same ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 16:53
-	0	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength bond\$4 resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4)) same (clamp\$4 grip\$4) same ceramic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 17:01
-	74	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength bond\$4 resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4)) same (clamp\$4 grip\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 13:10
-	209	73/827.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	81	73/830.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	122	73/834.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	3573	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near6 (pull\$4 push\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/09 17:52
-	31	(73/827.ccls. 73/830.ccls. 73/834.ccls.) and ((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near6 (pull\$4 push\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/08 17:33

-	103	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near6 (pull\$4 push\$4)) and (bolt\$4 near8 nut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/09 17:58
-	111	((lead wire cable bond\$4 strand) near6 (test\$4 monitor\$4 observ\$4 sens\$4 detect\$4 determin\$4) near6 (pull\$4 push\$4)) and (bolt\$4 near8 nut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/09 17:58
-	10	("5085084" "6230569" "4677370" "5753823" "5836071").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/09 19:40
-	5	("5085084" "6230569" "4677370" "5753823" "5836071").pn.	USPAT	2003/04/09 19:40
-	361	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 asses\$4 measur\$4 meter\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength bond\$4 resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4 force load\$4)) and ((clamp\$4 hold\$4 secur\$4 grip\$4) near4 (base package board substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:21
-	15	((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 asses\$4 measur\$4 meter\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength bond\$4 resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4 force load\$4)) and ((clamp\$4 hold\$4 secur\$4 grip\$4) near4 (base package board substrate))) and braz\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:22
-	346	73/818.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:37
-	216	73/827.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	83	73/830.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	123	73/834.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:29
-	13	(73/818.ccls. 73/827.ccls. 73/830.ccls. 73/834.ccls.) and (((lead wire cable strand) near6 (test\$4 monitor\$4 observ\$4 asses\$4 measur\$4 meter\$4 sens\$4 detect\$4 determin\$4) near4 (adhes\$4 adher\$4 join\$4 force strength bond\$4 resist\$4 weld\$4 fix\$4 secur\$4) near6 (pull\$4 push\$4 force load\$4)) and ((clamp\$4 hold\$4 secur\$4 grip\$4) near4 (base package board substrate)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/29 14:38